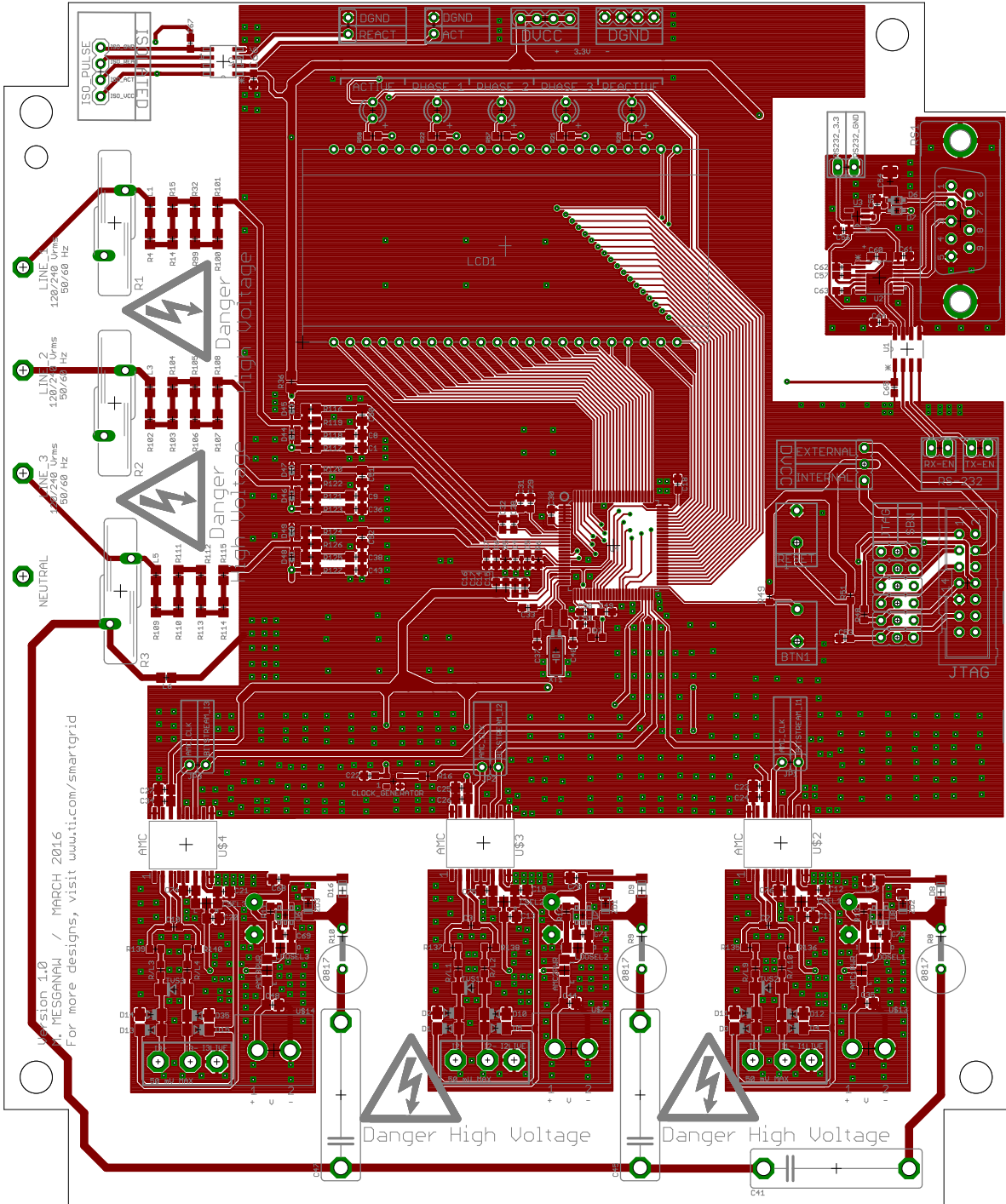
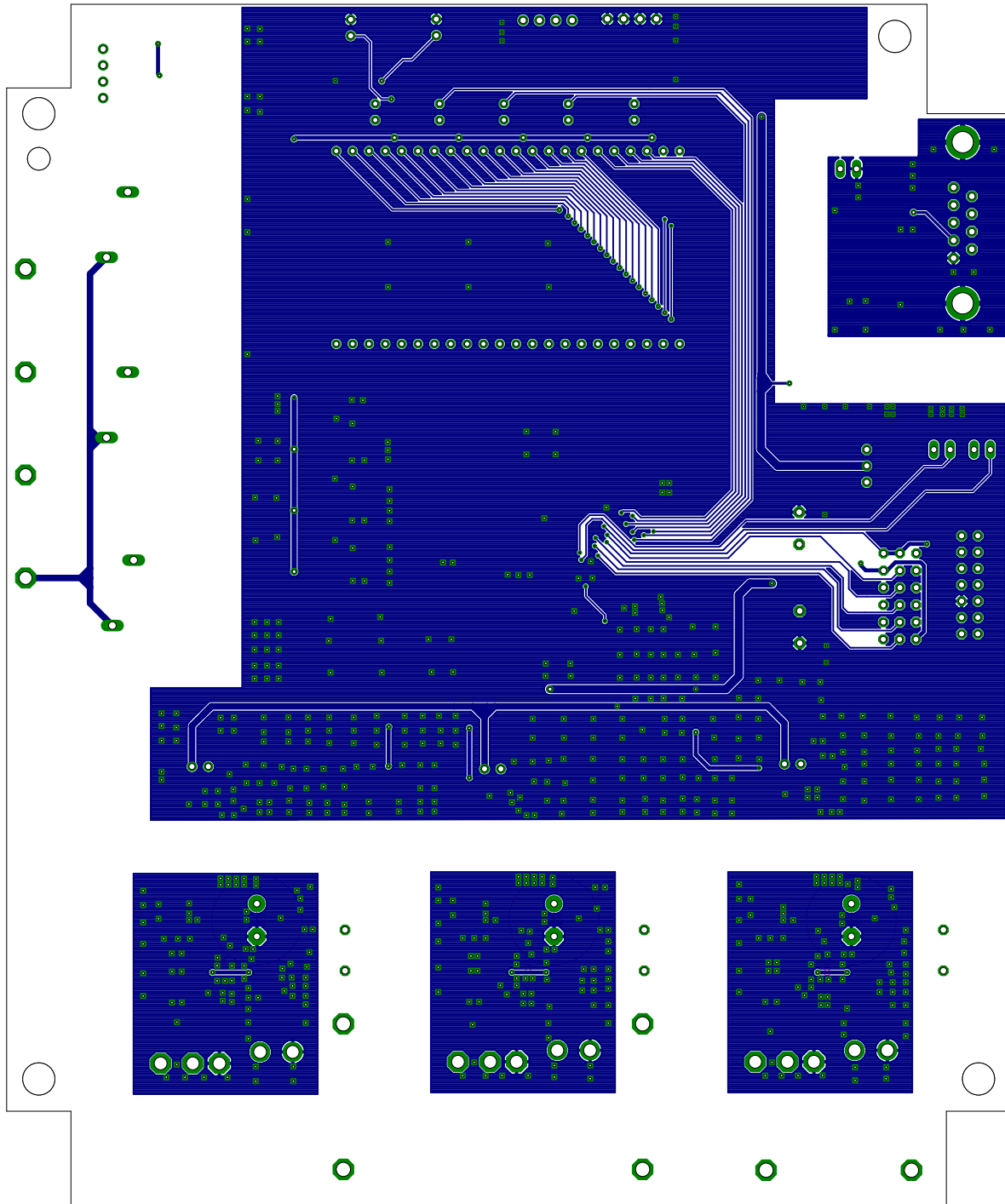


TIDA-01094 TOP LAYER



TIDA-01094
BOTTOM LAYER



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